

A

1. MATERIAL:

CONTACT: PHOSPHOR BRONZE

CONTACT: PHOSPHOR BRONZE

2. PLATING:

CONTACT AREA: 10u" GOLD OVER 50u" NICKEL
SOLDER TAIL: G/F OVER 50u" NICKEL

DETAIL 1
SCALE 5

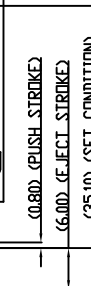
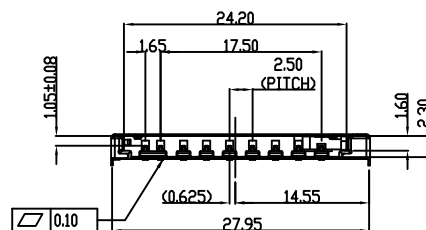
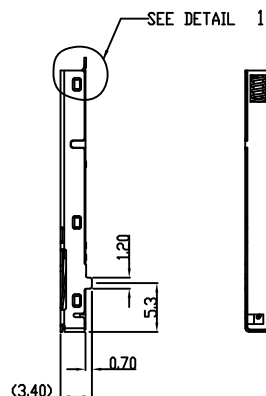


Figure 1 is a detailed plan view of the test specimen. It shows a rectangular layout with various dimensions and labels. Key features include:

- Dimensions:**
 - Overall width: 19.15
 - Overall height: 18.20
 - Top horizontal segments: 17.50, 0.625, 9.375
 - Left vertical segments: 1.20, 9.40, 8.10, 5.30, 1.40
 - Right vertical segments: 1.60, 30.30, 1.6
 - Bottom horizontal segments: 0.60, 0.40, 14.55
 - Internal horizontal segments: 14.00, 1.75, 1.55, 11.9, 1.4
 - Card center offset: 1.00 (TYP.)
 - Pitch: 2.50 (PITCH)
 - Bottom right offset: 3.3
- Labels and Components:**
 - CARD CENTER:** Indicated on the left side.
 - INSULATION AREA:** A shaded rectangular region in the center.
 - Sc:** A component labeled near the bottom left corner.
 - Wp:** A component labeled near the bottom left corner, above Sc.
 - Cd:** A component labeled near the bottom left corner, above Wp.
 - G:** A component labeled near the bottom right corner.
 - 2-1.60 (HOLE):** A label indicating two holes with a diameter of 1.60.
 - Card Connectors:** A row of nine connectors labeled 8, 7, 6, 5, 4, 3, 2, 1, 9 from left to right.

RECOMMEND PC BOARD LAYOUT
GENERAL TOLERANCE: $\pm 0.05\text{mm}$



1